

1. General description

Planar passivated Silicon Controlled Rectifier (SCR) in a SOT78 plastic package intended for use in applications requiring good bidirectional blocking voltage capability, high surge current capability and high thermal cycling performance.

2. Features and benefits

- Good bidirectional blocking voltage capability
- High surge current capability
- High thermal cycling performance

3. Applications

- Ignition circuits
- Motor control
- Protection circuits
- Voltage regulation

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|--|--|-----|-----|-----|------|
| V _{DRM} | repetitive peak off- state voltage | | - | - | 500 | V |
| V _{RRM} | repetitive peak reverse voltage | | - | - | 500 | V |
| I _{TSM} | non-repetitive peak on- state current | half sine wave; T _{j(init)} = 25 °C; t _p = 10 ms; <u>Fig. 4; Fig. 5</u> | - | - | 120 | A |
| | | half sine wave; T _{j(init)} = 25 °C; t _p = 8.3 ms | - | - | 132 | A |
| Тj | junction temperature | | - | - | 125 | °C |
| I _{T(AV)} | average on-state current | half sine wave; T _{mb} ≤ 109 °C; <u>Fig. 1</u> | - | - | 7.5 | A |
| I _{T(RMS)} | RMS on-state current | half sine wave; T _{mb} ≤ 109 °C; <u>Fig. 2;</u> <u>Fig. 3</u> | - | - | 12 | A |
| Static chara | acteristics | · | | | · | |
| I _{GT} | gate trigger current | V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u> | - | 2 | 15 | mA |
| Dynamic ch | naracteristics | | | | | |

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| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|-----------------------------------|---|-----|------|-----|------|
| dV _D /dt | rate of rise of off-state voltage | $\label{eq:DM} \begin{array}{l} V_{DM} = 335 \; V; \; T_{j} = 125 \; ^{\circ}\text{C}; \; R_{GK} = 100 \; \Omega; \\ (V_{DM} = 67\% \; of \; V_{DRM}); \; exponential \\ waveform; \; \underline{Fig. \; 12} \end{array}$ | 200 | 1000 | - | V/µs |

5. Pinning information

| Table 2 | . Pinning inf | formation | | |
|---------|---------------|-----------------------------------|--------------------|----------------------|
| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| 1 | К | cathode | mb | A - D K |
| 2 | А | anode | | Ğ sym037 |
| 3 | G | gate | | Symosi |
| mb | A | mounting base; connected to anode | | |
| | | | TO-220AB (SOT78) | |

6. Ordering information

Table 3. Ordering information

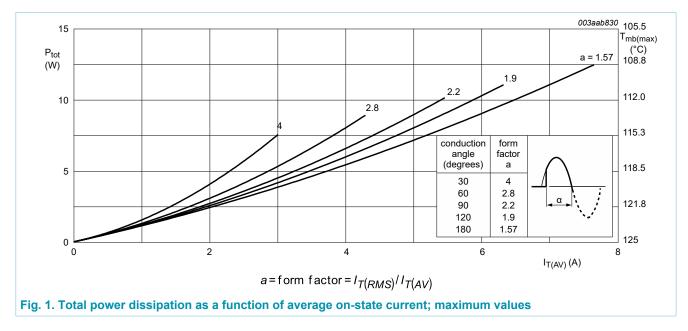
| Type number | Package | | | | | |
|-------------|----------|--|---------|--|--|--|
| | Name | Description | Version | | | |
| BT151-500R | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78 | | | |

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

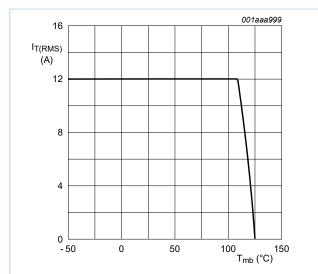
| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------|--|---|-----|-----|------|
| V _{DRM} | repetitive peak off-state voltage | | - | 500 | V |
| V _{RRM} | repetitive peak reverse voltage | | - | 500 | V |
| I _{T(AV)} | average on-state current | half sine wave; T _{mb} ≤ 109 °C; <u>Fig. 1</u> | - | 7.5 | А |
| I _{T(RMS)} | RMS on-state current | half sine wave; T _{mb} ≤ 109 °C; <u>Fig. 2;</u> <u>Fig. 3</u> | - | 12 | A |
| I _{TSM} | non-repetitive peak on- state current | half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5 | - | 120 | A |
| | | half sine wave; T _{j(init)} = 25 °C; t _p = 8.3 ms | - | 132 | А |
| l ² t | I ² t for fusing | t _p = 10 ms; SIN | - | 72 | A²s |
| dl _T /dt | rate of rise of on-state current | I _G = 30 mA | - | 50 | A/µs |
| I _{GM} | peak gate current | | - | 2 | А |
| V _{RGM} | peak reverse gate voltage | | - | 5 | V |
| P _{GM} | peak gate power | | - | 5 | W |
| P _{G(AV)} | average gate power | over any 20 ms period | - | 0.5 | W |
| T _{stg} | storage temperature | | -40 | 150 | °C |
| Tj | junction temperature | | - | 125 | °C |

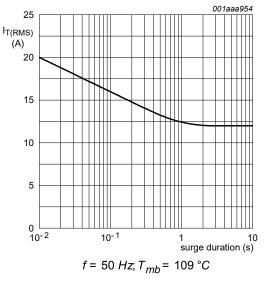


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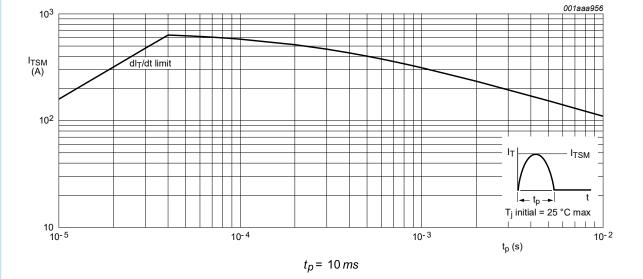
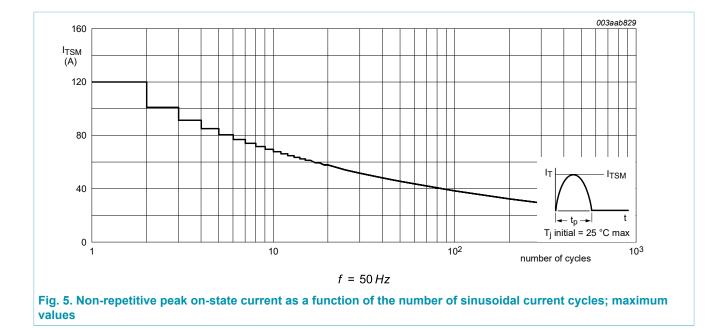


Fig. 4. Non-repetitive peak on-state current as a function of pulse width for sinusoidal currents; maximum values

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8. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|--|---------------|-----|-----|-----|------|
| R _{th(j-mb)} | thermal resistance from junction to mounting base | Fig. <u>6</u> | - | - | 1.3 | K/W |
| R _{th(j-a)} | thermal resistance from junction to ambient free air | in free air | - | 60 | - | K/W |

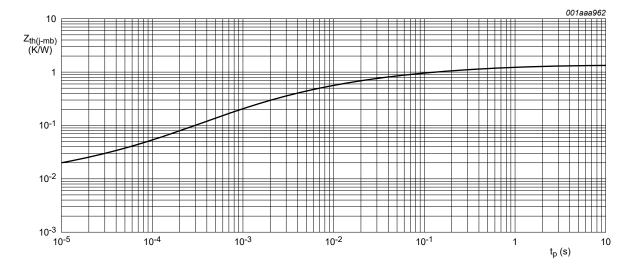


Fig. 6. Transient thermal impedance from junction to mounting base as a function of pulse width

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9. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|-----------------------------------|---|------|------|------|------|
| Static chara | acteristics | · | | | | |
| I _{GT} | gate trigger current | V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u> | - | 2 | 15 | mA |
| IL | latching current | V_D = 12 V; I_G = 0.1 A; T_j = 25 °C; <u>Fig. 8</u> | - | 10 | 40 | mA |
| I _H | holding current | V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u> | - | 7 | 20 | mA |
| V _T | on-state voltage | I _T = 23 A; T _j = 25 °C; <u>Fig. 10</u> | - | 1.4 | 1.75 | V |
| V _{GT} | gate trigger voltage | V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; Fig. 11 | - | 0.6 | 1.5 | V |
| | | V_D = 500 V; I _T = 0.1 A; T _j = 125 °C; Fig. 11 | 0.25 | 0.4 | - | V |
| I _D | off-state current | V _D = 500 V; T _j = 125 °C | - | 0.1 | 0.5 | mA |
| I _R | reverse current | V _R = 500 V; T _j = 125 °C | - | 0.1 | 0.5 | mA |
| Dynamic ch | aracteristics | | | | | |
| dV _D /dt | rate of rise of off-state voltage | $ V_{DM} = 335 \text{ V}; \text{T}_{\text{j}} = 125 ^{\circ}\text{C}; \text{R}_{\text{GK}} = 100 \Omega; \\ (\text{V}_{\text{DM}} = 67\% \text{ of } \text{V}_{\text{DRM}}); \text{ exponential} \\ waveform; \underline{\text{Fig. } 12} $ | 200 | 1000 | - | V/µs |
| | | V_{DM} = 335 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit; Fig. 12 | 50 | 130 | - | V/µs |
| t _{gt} | gate-controlled turn-on time | I_{TM} = 40 A; V _D = 500 V; I _G = 0.1 A; dI _G / dt = 5 A/µs; T _j = 25 °C | - | 2 | - | μs |
| t _q | commutated turn-off time | $V_{DM} = 335 \text{ V}; \text{ T}_{j} = 125 \text{ °C}; \text{ I}_{TM} = 20 \text{ A};$ $V_{R} = 25 \text{ V}; (dI_{T}/dt)_{M} = 30 \text{ A/}\mu\text{s}; dV_{D}/$ $dt = 50 \text{ V/}\mu\text{s}; \text{ R}_{GK(ext)} = 100 \Omega; (V_{DM} = 67\% \text{ of } V_{DRM})$ | - | 70 | - | μs |

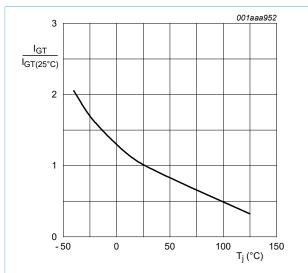
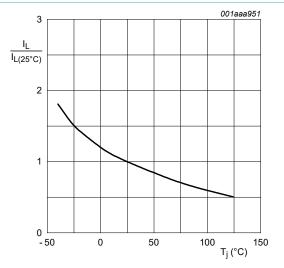


Fig. 7. Normalized gate trigger current as a function of junction temperature

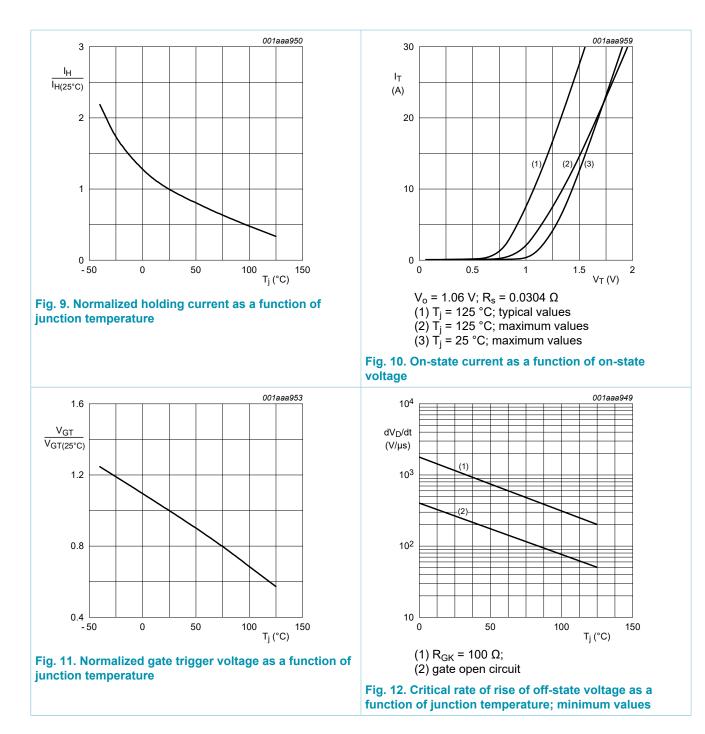




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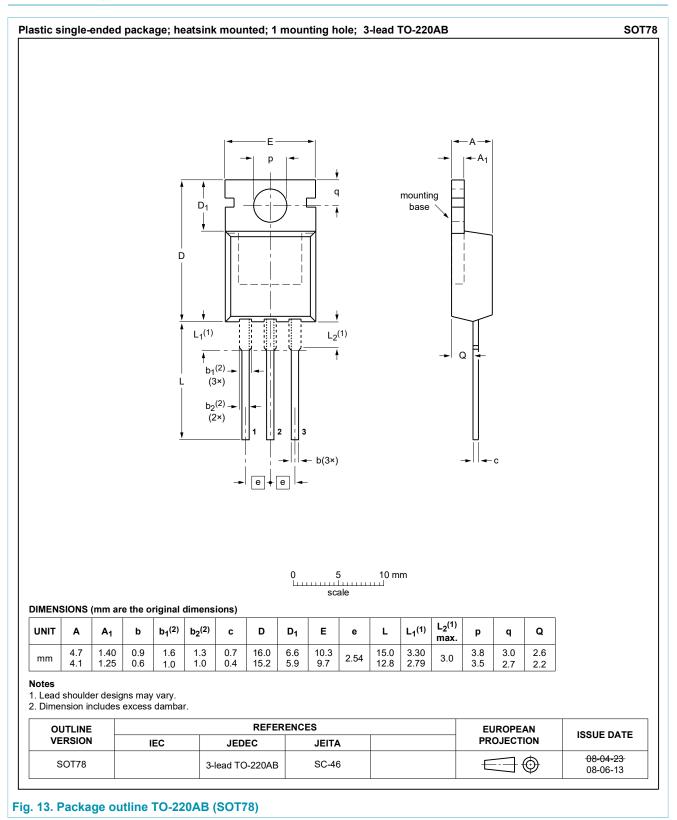
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10. Package outline



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11. Legal information

Data sheet status

| Document status [1][2] | Product status [<u>3]</u> | Definition |
|--------------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
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